# **BTL Driver Single-phase Full-wave for Motor Driver**

# **Monolithic Digital IC**

#### Overview

The LA6585MC is single-phase bipolar fan motor is driven, through BTL output linear drive, at high efficiency, low power, and low sound by suppressing the reactive power. Lock protection, rotary signal circuits are incorporated, which is optimum for the notebook PC, consumer equipment power supply, car audio system, CPU cooler, etc. that require high reliability and low noise.

#### **Functions and Features**

- Pre-driver for Single-phase Full-wave Drive
- Single-phase Full-wave Linear Drive by BTL Output (Gain Resistance 1 kΩ-360 kΩ, 51 dB):
   No Switching Noise, which is Optimum for Equipment Requiring Silence, such as Consumer Equipment Power Supply, Car Audio System, etc.
- Low-voltage Operation Possible, with Wide Operating Voltage Range (2.2 to 14.0 V)
- Low Saturation Output (Upper + Lower Saturation Voltage: V<sub>Osat</sub> (Total) = 1.2 V Typ, I<sub>O</sub> = 250 mA): High Coil Efficiency with Low Current Drain. Additionally, IC itself Generates only Small Heat
- Built-in Lock Protection and Automatic Reset Circuits
- Built-in FG & RD Outputs
- Built-in Hall bias ( $V_{HB} = 1.5 \text{ V}$ )
- Thermal Protection Circuit: When the Large Current Flows due to Output Short-circuit and the IC Chip Temperature Exceeds 180°C, this Protective Circuit Suppresses the Drive Current to Prevent Burn and Damage to IC.
- Extra-small & High Heat Capacity Package



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SOIC-10 NB CASE 751BQ

#### **MARKING DIAGRAM**

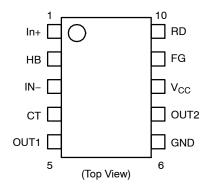


A6585 = Specific Device Code A = Assembly Location

A = Assembly Locati
L = Wafer Lot
Y = Year
W = Work Week

#### **PIN ASSIGNMENT**

= Pb-Free Package



## **ORDERING INFORMATION**

See detailed ordering and shipping information on page 5 of this data sheet.

#### **SPECIFICATIONS**

## ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

| Symbol                                 | Parameter                                 | Conditions                            | Ratings     | Unit |
|--|---|---------------------------------------|-------------|------|
| V <sub>CC</sub> max                    | Supply Voltage                            |                                       | 15          | V    |
| P <sub>d</sub> max                     | Allowable Power Dissipation               | Mounted on a specified board (Note 1) | 750         | mW   |
| I <sub>OUT</sub> max                   | Output Current                            |                                       | 0.7         | Α    |
| V <sub>OUT</sub> max                   | Output Withstand Voltage                  |                                       | 15          | V    |
| V <sub>RD/FG</sub> max                 | RD/FG Output Pin Output Withstand Voltage |                                       | 15          | V    |
| I <sub>RD/FG</sub> max                 | RD/FG Output Current                      |                                       | 10          | mA   |
| I <sub>B</sub> max                     | HB Output Current                         |                                       | 10          | mA   |
| T <sub>opr</sub> Operating Temperature |   |                                       | -30 to +90  | °C   |
| T <sub>stg</sub>                       | Storage Temperature                       |                                       | -55 to +150 | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## **OPERATING CONDITIONS** $(T_A = 25^{\circ}C)$

| Symbol Parameter               |  | Conditions | Ratings                   | Unit |
|--------------------------------|--|------------|---------------------------|------|
| V <sub>CC</sub> Supply Voltage |  |            | 2.2 to 14.0               | V    |
| V <sub>I</sub> CM              | Common-phase Input Voltage Range of Hall Input |            | 0 to V <sub>CC</sub> -1.5 | V    |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25$ °C, $V_{CC} = 12$ V, unless otherwise specified)

| Symbol              | Parameter                                       | Conditions  | Min  | Тур  | Max  | Unit |
|---------------------|---|---|------|------|------|------|
| I <sub>CC</sub> 1   | Circuit Current                                 | During drive (CT = L)                             | 3    | 6    | 9    | mA   |
| I <sub>CC</sub> 2   | 1   | During lock protection (CT = H)                   | 2.5  | 5    | 7.5  | mA   |
| I <sub>CT</sub> 1   | Lock Detection Capacitor Charge<br>Current      |   | 0.9  | 1.2  | 1.5  | μΑ   |
| I <sub>CT</sub> 2   | Capacitor Discharge Current                     |   | 0.10 | 0.18 | 0.25 | μΑ   |
| R <sub>CT</sub>     | Capacitor Charge and Discharge<br>Current Ratio | RCD = I <sub>CT</sub> 1/I <sub>CT</sub> 2         | 5    | 6.5  | 8    | -    |
| V <sub>CT</sub> 1   | CT Charge Voltage                               |   | 1.3  | 1.5  | 1.7  | V    |
| V <sub>CT</sub> 2   | CT Discharge Voltage                            |   | 0.3  | 0.5  | 0.7  | V    |
| V <sub>OL</sub>     | OUT Output L Saturation Voltage                 | I <sub>O</sub> = 200 mA                           | _    | 0.25 | 0.45 | V    |
| V <sub>OH</sub>     | OUT Output H Saturation Voltage                 | I <sub>O</sub> = 200 mA                           | -    | 0.95 | 1.2  | V    |
| V <sub>HN</sub>     | Hall Input Sensitivity                          | Zero peak value (including offset and hysteresis) | =    | 7    | 15   | mV   |
| V <sub>HB</sub>     | Hall Bias Voltage                               | I <sub>HB</sub> = 5 mA                            | 1.3  | 1.5  | 1.7  | V    |
| V <sub>FG/RD</sub>  | FG/RD Output Pin L Voltage                      | I <sub>RD/FG</sub> = 5 mA                         | -    | 0.15 | 0.3  | V    |
| I <sub>FG/RDL</sub> | FG/RD Output Pin Leak Current                   | V <sub>RD/FG</sub> = 15 V                         | -    | 1    | 30   | μΑ   |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

<sup>1.</sup> Mounted on a specified board: 114.3 mm × 76.1 mm × 1.6 mm glass epoxy.

## **TRUTH TABLE**

| IN- | IN+ | СТ | OUT1 | OUT2 | FG | RD | Mode                       |
|-----|-----|----|------|------|----|----|----------------------------|
| Н   | L   | L  | Н    | L    | L  | L  | During rotation            |
| L   | Н   |    | L    | Н    | Н  |    |                            |
| -   | -   | Н  | Off  | Off  | -  | Н  | During overheat protection |

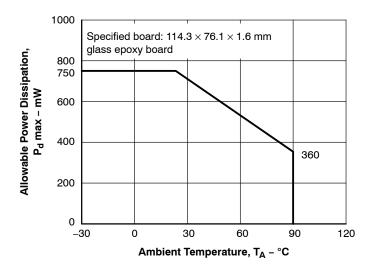


Figure 1. P<sub>d</sub> max – T<sub>A</sub>

## **BLOCK DIAGRAM**

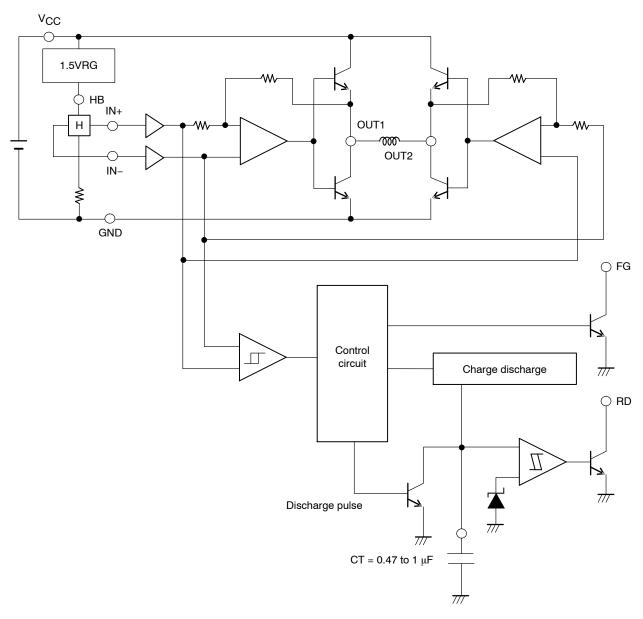


Figure 2. Block Diagram

#### **APPLICATION CIRCUIT**

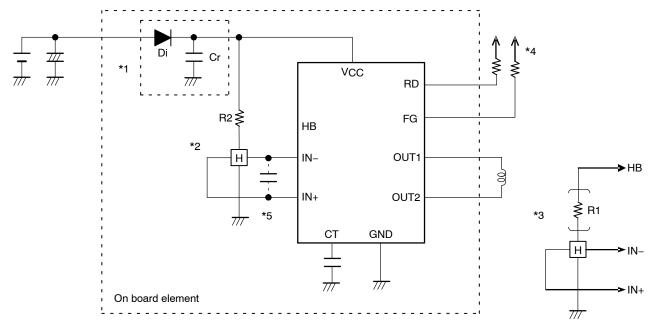


Figure 3. Sample Application Circuit

- \*1: When the breakdown protective DI at reverse connection is to be used, it is necessary to insert the capacitor Cr to secure the regenerative current route. Similarly, Cr must be provided to enhance the reliability when there is no capacitor near the fan power line.
- \*2: To obtain Hall bias from V<sub>CC</sub>, carry out bias to V<sub>CC</sub> with resister R2 as shown in the figure. Linear driving is made through voltage control of the coil by amplifying the Hall output. When the Hall element output is large, the startup performance and efficiency are improved. Adjustment of the Hall element can reduce the noise further.
- \*3: To obtain Hall bias from the HB pin, carry out constant-voltage bias at about 1.5 V, which enables the Hall element to generate the stable Hall output satisfactory in temperature characteristics. Adjustment of the Hall output amplitude is made with R1. (When  $V_{CC} = 12$  V, the step \*2 above proves advantageous for IC heat generation.)
- \*4: Keep this open when not using.
- \*5: When the wiring from the Hall output to IC Hall input is long, noise may be carried through the wiring.

  In this case, insert the capacitor as shown in the figure.

## **ORDERING INFORMATION**

| Device        | Package                                | Wire Bond Shipping <sup>†</sup> (Qty / Pad |                     |  | Package Wire Bond Ship |  |
|---------------|--|--|---------------------|--|------------------------|--|
| LA6585MC-AH   | SOIC-10 NB<br>(Pb-Free / Halogen Free) | Au wire                                    | 2,000 / Tape & Reel |  |                        |  |
| LA6585MC-AH-M | SOIC-10 NB<br>(Pb-Free / Halogen Free) | Au wire                                    | 2,000 / Tape & Reel |  |                        |  |

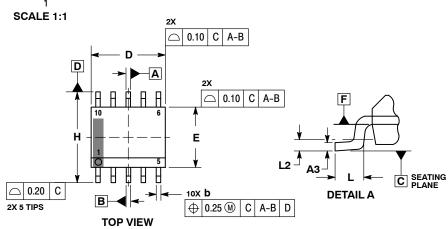
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

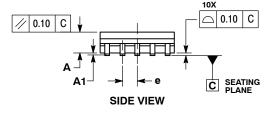
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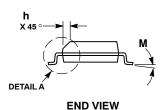




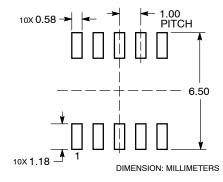
**ISSUE B** 







## **RECOMMENDED SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

  2. CONTROLLING DIMENSION: MILLIMETERS.

  3. DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION.
- AT MAXIMUM MATERIAL CONDITION.

  SHALL BE 0.10mm TOTAL IN EXCESS OF 'b'

  AT MAXIMUM MATERIAL CONDITION.

  DIMENSIONS D AND E DO NOT INCLUDE

  MOLD FLASH, PROTRUSIONS, OR GATE

  BURRS. MOLD FLASH, PROTRUSIONS, OR

  GATE BURRS SHALL NOT EXCEED 0.15mm PER SIDE. DIMENSIONS D AND E ARE DETERMINED AT DATUM F.
- DIMENSIONS A AND B ARE TO BE DETERM-INED AT DATUM F.
- INED AT DATUM F. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

|     | MILLIMETERS |          |  |  |  |
|-----|-------------|----------|--|--|--|
| DIM | MIN         | MAX      |  |  |  |
| Α   | 1.25        | 1.75     |  |  |  |
| A1  | 0.10        | 0.25     |  |  |  |
| A3  | 0.17        | 0.25     |  |  |  |
| b   | 0.31        | 0.51     |  |  |  |
| D   | 4.80        | 5.00     |  |  |  |
| Е   | 3.80        | 4.00     |  |  |  |
| е   | 1.00        | 1.00 BSC |  |  |  |
| Н   | 5.80        | 6.20     |  |  |  |
| h   | 0.37        | REF      |  |  |  |
| L   | 0.40        | 0.80     |  |  |  |
| L2  | 0.25 BSC    |          |  |  |  |
| М   | 0° 8°       |          |  |  |  |

### **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code

Α = Assembly Location = Wafer Lot L

Υ = Year W = Work Week

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

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| ISSUE | REVISION  | DATE        |
|-------|---|-------------|
| 0     | RELEASED FOR PRODUCTION. REQ. BY M. RAMOS.                    | 06 JUL 2010 |
| Α     | CHANGED DIMENSION A MIN FROM 1.35 TO 1.25. REQ. BY HB TAN.    | 25 APR 2011 |
| В     | CHANGED DIMENSION L MAX FROM 1.27 TO 0.80 MM. REQ. BY C. TAN. | 26 NOV 2013 |
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